## STF20N65M5, STFI20N65M5, STFW20N65M5

N-channel 650 V, $0.160 \Omega$ typ., 18 A MDmesh M5 Power MOSFETs in TO-220FP, I2PAKFP and TO-3PF packages

Datasheet - production data


Figure 1: Internal schematic diagram


Features

| Order code | V ${ }_{\text {DS }}$ @ $\mathrm{T}_{\text {Jmax }}$ | R ${ }_{\text {dS(on) }}$ max | ID |
| :---: | :---: | :---: | :---: |
| STF20N65M5 | 710 V | $0.190 \Omega$ | 18 A |
| STFI20N65M5 |  |  |  |
| STFW20N65M5 |  |  |  |

- Extremely low Ros(on)
- Low gate charge and input capacitance
- Excellent switching performance
- $100 \%$ avalanche tested


## Applications

- Switching applications


## Description

These devices are N-channel Power MOSFET based on the MDmesh ${ }^{\text {TM }}$ M5 innovative vertical process technology combined with the wellknown PowerMESH ${ }^{\text {TM }}$ horizontal layout. The resulting products offer extremely low onresistance, making them particularly suitable for applications requiring high power and superior efficiency.

Table 1: Device summary

| Order code | Marking | Package | Packaging |
| :---: | :---: | :---: | :---: |
| STF20N65M5 |  | TO-220FP |  |
| STFI20N65M5 | 20N65M5 | Tube |  |
|  |  | I2PAKFP (TO-281) |  |
|  |  | TO-3FP |  |

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## 1

## Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value |  | Unit |
| :---: | :---: | :---: | :---: | :---: |
|  |  | TO-220FP, I2PAKFP | TO-3PF |  |
| $V_{G S}$ | Gate- source voltage | $\pm 25$ |  | V |
| ID | Drain current (continuous) at $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $18^{(1)}$ |  | A |
| ID | Drain current (continuous) at $\mathrm{T}^{\text {c }}=100^{\circ} \mathrm{C}$ | $11.3{ }^{(1)}$ |  | A |
| Idm ${ }^{(2)}$ | Drain current (pulsed) | $36{ }^{(1)}$ |  | A |
| Рtot | Total dissipation at $\mathrm{T} \mathrm{C}=25^{\circ} \mathrm{C}$ | 30 | 48 | W |
| dv/dt ${ }^{(3)}$ | Peak diode recovery voltage slope | 15 |  | V/ns |
| $\mathrm{V}_{\text {ISO }}{ }^{(4)}$ | Insulation withstand voltage (RMS) from all three leads to external heat sink ( $\mathrm{t}=1 \mathrm{~s}$; $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ ) | 2500 | 3500 | V |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range | - 55 to 150 |  | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{j}}$ | Operating junction temperature range |  |  |  |

## Notes:

${ }^{(1)}$ Limited by maximum junction temperature.
${ }^{(2)}$ Pulse width limited by safe operating area
${ }^{(3)} \mathrm{I}_{\mathrm{SD}} \leq 18 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=400 \mathrm{~A} / \mu \mathrm{S}, \mathrm{V}_{\mathrm{DS}(\text { peak })}<\mathrm{V}_{(\mathrm{BR}) \mathrm{DSS}}, \mathrm{V}_{\mathrm{DD}}=400 \mathrm{~V}$
${ }^{(4)} \mathrm{V}_{\mathrm{DS}} \leq 520 \mathrm{~V}$

Table 3: Thermal data

| Symbol | Parameter | Value |  | Unit |
| :---: | :--- | :---: | :---: | :---: |
|  |  | TO-220FP, <br> I2PAKFP | TO-3PF |  |
| $R_{\text {thj-case }}$ | Thermal resistance junction-case | 4.17 | 2.6 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $R_{\text {thj-amb }}$ | Thermal resistance junction-ambient | 62.5 | 50 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Table 4: Avalanche characteristics

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| IAR | Avalanche current, repetitive or not repetitive <br> (pulse width limited by $\left.T_{j m a x}\right)$ | 4 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{E}_{\mathrm{AS}}$ | Single pulse avalanche energy <br> $\left(\right.$ starting $\mathrm{T}_{J}=25^{\circ} \mathrm{C}, \mathrm{I}_{\mathrm{D}}=\mathrm{I}_{\mathrm{AR}}, \mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V}$ ) | 270 | mJ |

## 2 Electrical characteristics

( $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise specified)
Table 5: On /off states

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {(BR)DSS }}$ | Drain-source breakdown voltage | $\mathrm{V}_{\mathrm{GS}}=0, \mathrm{ld}=1 \mathrm{~mA}$ | 650 |  |  | V |
| Idss | Zero gate voltage drain current | $\mathrm{V}_{\mathrm{GS}}=0, \mathrm{~V}_{\mathrm{DS}}=650 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{GS}}=0, \mathrm{~V}_{\mathrm{DS}}=650 \mathrm{~V}, \\ & \mathrm{~T}_{\mathrm{C}}=125^{\circ} \mathrm{C}{ }^{(1)} \end{aligned}$ |  |  | 100 | $\mu \mathrm{A}$ |
| Igss | Gate-body leakage current | $\mathrm{V}_{\mathrm{DS}}=0, \mathrm{~V}_{\mathrm{GS}}= \pm 25 \mathrm{~V}$ |  |  | $\pm 100$ | nA |
| $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | Gate threshold voltage | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 3 | 4 | 5 | V |
| RDs(on) | Static drain-source onresistance | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{ld}=9 \mathrm{~A}$ |  | 0.160 | 0.190 | $\Omega$ |

## Notes:

${ }^{(1)}$ Defined by design, not subject to production test

Table 6: Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Ciss | Input capacitance | $\begin{aligned} & V_{G S}=0, V_{D S}=100 \mathrm{~V}, \\ & f=1 \mathrm{MHz} \end{aligned}$ | - | 1434 | - | pF |
| Coss | Output capacitance |  | - | 38 | - | pF |
| Crss | Reverse transfer capacitance |  | - | 3.7 | - | pF |
| $\mathrm{C}_{0(\text { (r) }}{ }^{(1)}$ | Equivalent capacitance time related | $\mathrm{V}_{\mathrm{GS}}=0, \mathrm{~V}_{\mathrm{DS}}=0$ to 520 V | - | 118 | - | pF |
| $\mathrm{Co}_{\text {(er) }}{ }^{(2)}$ | Equivalent capacitance energy related |  | - | 35 | - | pF |
| $\mathrm{R}_{\mathrm{G}}$ | Intrinsic gate resistance | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{Id}_{\mathrm{D}}=0 \mathrm{~A}$ | - | 3.5 | - | $\Omega$ |
| $\mathrm{Q}_{\mathrm{g}}$ | Total gate charge | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=520 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=9 \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{GS}}=0 \text { to } 10 \mathrm{~V} \end{aligned}$ <br> (see Figure 18: "Test circuit for gate charge behavior") | - | 36 | - | nC |
| Qgs | Gate-source charge |  | - | 7.5 | - | nC |
| $Q_{g d}$ | Gate-drain charge |  | - | 18 | - | nC |

## Notes:

${ }^{(1)} \mathrm{C}_{0}(\mathrm{rr})$ is a constant capacitance value that gives the same charging time as $\mathrm{C}_{\text {oss }}$ while $\mathrm{V}_{\mathrm{DS}}$ is rising from 0 to $80 \%$ Vdss.
${ }^{(2)} \mathrm{C}_{o(e r)}$ is a constant capacitance value that gives the same stored energy as Coss while $V_{D S}$ is rising from 0 to $80 \%$ VDss.

Table 7: Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {d }}(\mathrm{V})$ | Voltage delay time | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=400 \mathrm{~V}, \mathrm{ID}_{\mathrm{D}}=12 \mathrm{~A}, \\ & \mathrm{R}_{\mathrm{G}}=4.7 \Omega, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V} \end{aligned}$ <br> (see Figure 19: "Test circuit for inductive load switching and diode recovery times" and Figure 22: "Switching time waveform") |  | 43 |  | ns |
| tr(v) | Voltage rise time |  | - | 7.5 | - | ns |
| $\mathrm{t}_{\text {(i) }}$ | Current fall time |  | - | 7.5 | - | ns |
| $\mathrm{tc}_{\text {(off) }}$ | Crossing time |  | - | 11.5 | - | ns |

Table 8: Source drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Iso | Source-drain current |  | - |  | 18 | A |
| Ismm ${ }^{(1)}$ | Source-drain current (pulsed) |  | - |  | 36 | A |
| $\mathrm{VSD}^{(2)}$ | Forward on voltage | $\mathrm{ISD}=18 \mathrm{~A}, \mathrm{VGS}=0$ | - |  | 1.5 | V |
| $t_{\text {rr }}$ | Reverse recovery time | $\begin{aligned} & \mathrm{ISD}=18 \mathrm{~A}, \\ & \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s} \\ & \mathrm{~V}_{\mathrm{DD}}=100 \mathrm{~V} \end{aligned}$ <br> (see Figure 19: "Test circuit for inductive load switching and diode recovery times") | - | 288 |  | ns |
| $\mathrm{Q}_{\mathrm{r}}$ | Reverse recovery charge |  | - | 4 |  | $\mu \mathrm{C}$ |
| IRRM | Reverse recovery current |  | - | 27 |  | A |
| $\mathrm{trr}^{\text {r }}$ | Reverse recovery time | $\begin{aligned} & \mathrm{ISD}=18 \mathrm{~A}, \\ & \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{S} \\ & \mathrm{~V}_{\mathrm{DD}}=100 \mathrm{~V}, \mathrm{~T}_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ <br> (see Figure 19: "Test circuit for inductive load switching and diode recovery times") | - | 342 |  | ns |
| $Q_{r r}$ | Reverse recovery charge |  | - | 4.7 |  | $\mu \mathrm{C}$ |
| IRRM | Reverse recovery current |  | - | 28 |  | A |

## Notes:

${ }^{(1)}$ Pulse width limited by safe operating area
${ }^{(2)}$ Pulsed: pulse duration $=300 \mu$ s, duty cycle $1.5 \%$

### 2.1 Electrical characteristics (curve)

Figure 2: Safe operating area for TO-220FP and I2PAKFP


Figure 3: Thermal impedance for for TO-220FP and I2PAKFP


Figure 4: Safe operating area for TO-3PF


Figure 5: Thermal impedance for TO-3PF


Figure 6: Output characteristics


Figure 7: Tranfer characteristics



Figure 10: Capacitance variations


Figure 9: Static drain-source on-resistance


Figure 11: Output capacitance stored energy


Figure 12: Normalized gate threshold voltage vs temperature


Figure 13: Normalized on-resistance vs temperature



Figure 16: Switching energy vs gate resistance


Eon including reverse recovery of a SiC diode.

## 3 Test circuits



## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK ${ }^{\circledR}$ packages, depending on their level of environmental compliance. ECOPACK ${ }^{\circledR}$ specifications, grade definitions and product status are available at: www.st.com. ECOPACK ${ }^{\circledR}$ is an ST trademark.

### 4.1 TO-220FP package information

Figure 23: TO-220FP package outline


Table 9: TO-220FP package mechanical data

| Dim. | mm |  |  |
| :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. |
| A | 4.4 |  | 4.6 |
| B | 2.5 |  | 2.7 |
| D | 2.5 |  | 2.75 |
| E | 0.45 |  | 0.7 |
| F | 0.75 |  | 1 |
| F1 | 1.15 |  | 1.70 |
| F2 | 1.15 |  | 1.70 |
| G | 4.95 |  | 5.2 |
| G1 | 2.4 |  | 2.7 |
| H | 10 |  | 10.4 |
| L2 | 28.6 |  | 30.6 |
| L3 | 9.8 |  | 10.6 |
| L4 | 2.9 |  | 3.6 |
| L5 | 15.9 |  | 16.4 |
| L6 | 9 |  | 9.3 |
| L7 | 3 |  | 3.2 |
| Dia |  |  |  |

$4.2 \quad$ I2PAKFP (TO-281) package information
Figure 24: I2PAKFP (TO-281) package outline


Table 10: I2PAKFP (TO-281) mechanical data

| Dim. | mm |  |  |
| :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. |
| A | 4.40 |  | 4.60 |
| B | 2.50 |  | 2.70 |
| D | 2.50 |  | 2.75 |
| D1 | 0.65 |  | 0.85 |
| E | 0.45 |  | 0.70 |
| F | 0.75 |  | 1.00 |
| F1 |  |  | 1.20 |
| G | 4.95 |  | 5.20 |
| H | 10.00 |  | 10.40 |
| L1 | 21.00 |  | 23.00 |
| L2 | 13.20 |  | 14.10 |
| L3 | 10.55 |  | 10.85 |
| L4 | 2.70 |  | 3.20 |
| L5 | 0.85 |  | 1.25 |
| L6 | 7.50 |  | 7.70 |

4.3 TO-3PF package information

Figure 25: TO-3PF package outline


Table 11: TO-3PF mechanical data

| Dim. | mm |  |  |
| :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. |
| A | 5.30 |  | 5.70 |
| C | 2.80 |  | 3.20 |
| D | 3.10 |  | 3.50 |
| D1 | 1.80 |  | 2.20 |
| E | 0.80 |  | 1.10 |
| F | 0.65 |  | 0.95 |
| F2 | 1.80 |  | 2.20 |
| G | 10.30 |  | 11.50 |
| G1 | 15.30 |  | 10 |
| H | 9.80 |  | 10.70 |
| L | 22.80 |  | 23.20 |
| L2 | 26.30 |  | 26.70 |
| L3 | 43.20 |  | 44.40 |
| L4 | 4.30 |  | 24.70 |
| L5 | 24.30 |  | 15 |
| L6 | 14.60 |  | 2.20 |
| L7 | 1.80 |  | 4.20 |
| N | 3.80 |  | 3.80 |
| R | 3.40 |  |  |
| Dia |  |  |  |
|  |  |  |  |

## 5 Revision history

Table 12: Document revision history

| Date | Revision | Changes |
| :---: | :---: | :--- |
| 01-Feb-2013 | 1 | $\begin{array}{l}\text { First release. Part numbers previously included in datasheet } \\ \text { DM00049308 }\end{array}$ |
| 21-Jul-2016 | 2 | $\begin{array}{l}\text { Added device in TO-3PF. } \\ \text { Modified: Table 2: "Absolute maximum ratings", Table 5: "On /off } \\ \text { states". } \\ \text { Modified: Figure 2: "Safe operating area for TO-220FP and 12PAKFP", } \\ \text { Figure 4: "Safe operating area for TO-3PF", Figure 5: "Thermal } \\ \text { impedance for TO-3PF". }\end{array}$ |
| Minor text changes |  |  |$]$| Modified Table 2: "Absolute maximum ratings", Table 8: "Source drain |
| :--- |
| diode". |
| Modified Figure 2: "Safe operating area for TO-220FP and I2PAKFP", |
| 22-Mar-2017 |
| Figure 4: "Safe operating area for TO-3PF", Figure 12: "Normalized |
| gate threshold voltage vs temperature ", Figure 13: "Normalized on- |
| resistance vs temperature" and Figure 14: "Source-drain diode |
| forward characteristics ". |
| Minor text changes. |

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